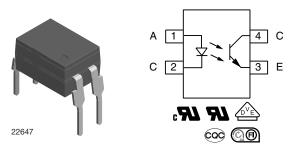


Low Input Current Optocoupler, Phototransistor Output, High Reliability, 5300 V_{RMS}



DESCRIPTION

The 110 °C rated VO617C feature a high current transfer ratio, low coupling capacitance and high isolation voltage. These couplers have a GaAs infrared diode emitter, which is optically coupled to a silicon planar phototransistor detector, and is incorporated in a plastic DIP-4 package.

The coupling devices are designed for signal transmission between two electrically separated circuits.

FEATURES

- · Copper lead-frame
- Operating temperature from 55 °C to + 110 °C
- Isolation test voltage, 5300 V_{RMS}
- High collector emitter voltage, V_{CEO} = 80 V
- Low saturation voltage
- · Fast switching times
- Low CTR degradation
- Low coupling capacitance
- End stackable, 0.100" (2.54 mm) spacing
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>





COMPLIANT HALOGEN

GREEN (5-2008)

APPLICATIONS

- AC adapters
- SMPS
- PLC
- · Factory automation
- Solar inverter

AGENCY APPROVALS

- UL1577, file no. E52744
- cUL tested to CSA 22.2 bulletin 5A
- DIN EN 60747-5-5 (VDE 0884), available with option 1
- FIMKO EN 60065 and EN60950-1, file no. FI 27409
- CQC GB8898-2001

ORDERING INFORMATION						
V O 6 1 7 C - # X O # # PART NUMBER CTR PACKAGE OPTION Option 6 Option 7 Option 7 Option 7 Option 7 Option 9 > 8 mm - > 8 mm						
AGENCY CERTIFIED/PACKAGE	CTR (%)					
AGENCY CENTIFIED/FACRAGE	5 mA					
UL, cUL, BSI, FIMKO, CQC	40 to 80	63 to 125	100 to 200	160 to 320		
DIP-4	-	VO617C-2	-	-		
SMD-4, option 9	=	VO617C-2X009T	-	-		
VDE, UL, cUL, BSI, FIMKO, CQC	40 to 80	63 to 125	100 to 200	160 to 320		
DIP-4	-	VO617C-2X001	VO617C-3X001	VO617C-4X001		
DIP-4, 400 mil, option 6	VO617C-1X016	VO617C-2X016	VO617C-3X016	VO617C-4X016		
SMD-4, option 7		-	VO617C-3X017T1 (1)			

Notes

• Additional options may be available, please contact the sales office.

(1) T1 rotation in tape and reel packing.



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)								
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT				
INPUT								
Reverse voltage		V_{R}	6	V				
Forward current		I _F	60	mA				
Forward surge current	t _p ≤ 10 μs	I _{FSM}	2.5	Α				
Power dissipation	at 25 °C	P _{diss}	70	mW				
OUTPUT	·							
Collector emitter voltage		V _{CEO}	80	V				
Emitter collector voltage		V _{ECO}	7	V				
Collector current		,	50	mA				
	t _p ≤ 1 ms	Ic	100	mA				
Ouput power dissipation	at 25 °C	P _{diss}	150	mW				
COUPLER	·							
Isolation test voltage (RMS)	t = 1 min	V _{ISO}	5300	V _{RMS}				
Total power dissipation		P _{tot}	200	mW				
Operation temperature		T _{amb}	- 55 to + 110	°C				
Storage temperature range		T _{stg}	- 55 to + 150	°C				
Junction temperature		T _i	125	°C				
Soldering temperature (1)	2 mm from case, ≤ 10 s	T _{sld}	260	°C				

Notes

(2) Refer to wave profile for soldering conditions for through hole devices (DIP).

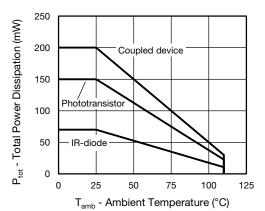


Fig. 1 - Total Power Dissipation vs. Ambient Temperature

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION SYMBOL MIN.			TYP.	MAX.	UNIT	
INPUT							
Forward voltage	I _F = 60 mA	V_{F}		1.1	1.6	V	
Reverse current	V _R = 6 V	I _R		0.01	10	μA	
Junction capacitance	$V_R = 0 V, f = 1 MHz$	C _i		9		pF	
OUTPUT							
Collector emitter leakage current	V _{CE} = 10 V	I _{CEO}		0.3	100	nA	
Collector emitter capacitance	$V_{CE} = 5 \text{ V}, f = 1 \text{ MHz}$	C _{CE}		2.8		pF	
Collector emitter breakdown voltage	I _C = 100 μA	BV _{CEO}	80			V	
Emitter collector breakdown voltage	I _E = 10 μA	BV _{ECO}	7			V	
COUPLER							
Collector emitter saturation voltage	$I_F = 10 \text{ mA}, I_C = 2.5 \text{ mA}$	V _{CEsat}		0.25	0.4	V	
Coupling capacitance	f = 1 MHz	C _{IO}		0.3		pF	
Cut-off frequency	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 100 \Omega$	f _{ctr}		110		kHz	

Note

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
evaluation. Typical values are for information only and are not part of the testing requirements.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.



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CURRENT TRANSFER RATIO (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
I _O /I _F	I 5 m	VO617C-1	CTR	40		80	%
		VO617C-2	CTR	63		125	%
	$I_F = 5 \text{ mA}, V_{CE} = 5 \text{ V}$	VO617C-3	CTR	100		200	%
		VO617C-4	CTR	160		320	%

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
NON-SATURATED							
Rise time	$I_{C} = 2 \text{ mA}, V_{CC} = 5 \text{ V}, R_{L} = 100 \Omega$	t _r		3		μs	
Fall time		t _f		3		μs	
Turn-on time		t _{on}		6		μs	
Turn-off time		t _{off}		4		μs	
SATURATED							
Rise time	1 16 mA V 5 V D 10 kO	t _r		7		μs	
Fall time		t _f		12		μs	
Turn-on time	$I_F = 1.6 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 1.9 \text{ k}Ω$	t _{on}		9		μs	
Turn-off time		t _{off}		15		μs	

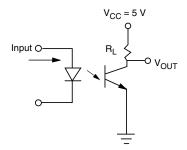


Fig. 2 - Test Circuit

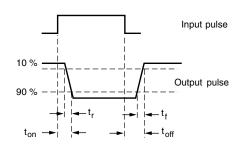


Fig. 3 - Test Circuit and Waveforms

SAFETY AND INSULATION RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT			
MAXIMUM SAFETY RATINGS						
Output safety power		P _{SO}	700	mW		
Input safety current		I _{si}	400	mW		
Safety temperature		T _S	175	°C		
Comparative tracking index		CTI	175			
INSULATION RATED PARAMETERS						
Maximum withstanding isolation voltage		V _{ISO}	5300	V_{RMS}		
Maximum transient isolation voltage		V _{IOTM}	8000	V_{peak}		
Manifestory and Athle and I in that it is a sale to a sale to a sale and		V_{IORM}	565	V_{peak}		
Maximum repetitive peak isolation voltage		V _{IORM} (1)	1140	V_{peak}		
Insulation resistance	$T_{amb} = 25 ^{\circ}C, V_{DC} = 500 V$	R _{IO}	10 ¹²	Ω		
Isolation resistance	$T_{amb} = 100 ^{\circ}\text{C}, V_{DC} = 500 \text{V}$	R _{IO}	10 ¹¹	Ω		
Climatic classification (according to IEC 68	part 1)		55/110/21			
Environment (pollution degree in accordance	e to DIN VDE 0109)		2			
Internal and external erechage	Standard DIP-4		≥ 7	mm		
Internal and external creepage	400 mil DIP-4, SMD-4 option 9		≥ 8	mm		
Clearance	Standard DIP-4		≥ 7	mm		
Clearance	400 mil DIP-4, SMD-4 option 9		≥ 8	mm		
Insulation thickness		0.4	mm			

Notes

As per DIN EN 60747-5-5, § 7.4.3.8.2), this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.
 Only for option 6.

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

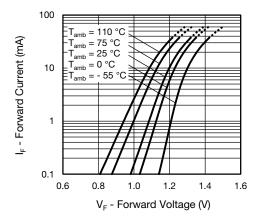


Fig. 4 - Forward Voltage vs. Forward Current

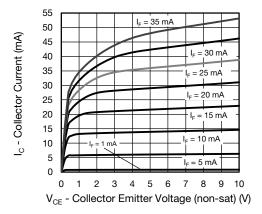


Fig. 5 - Collector Current vs. Collector Emitter Voltage (NS)

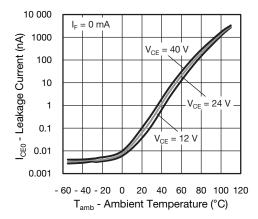


Fig. 6 - Leakage Current vs. Ambient Temperature

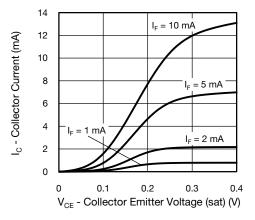


Fig. 7 - Collector Current vs. Collector Emitter Voltage (saturated)

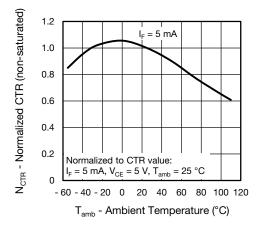


Fig. 8 - Normalized Current Transfer Ratio (non-saturated) vs.
Ambient Temperature

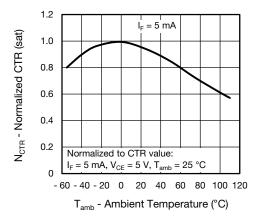
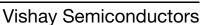


Fig. 9 - Normalized Current Transfer Ratio (saturated) vs.
Ambient Temperature





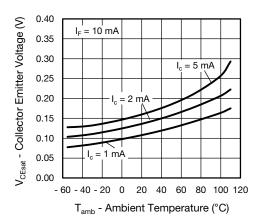


Fig. 10 - Collector Emitter Voltage vs. Ambient Temperature (saturated)

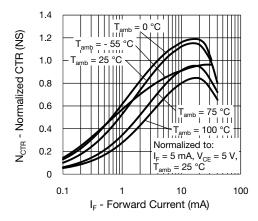


Fig. 11 - Normalized CTR (non-saturated) vs. Forward Current

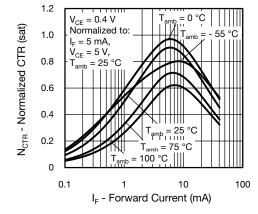


Fig. 12 - Normalized CTR (saturated) vs. Forward Current

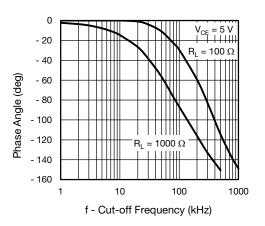


Fig. 13 - F_{CTR} vs. Phase Angle

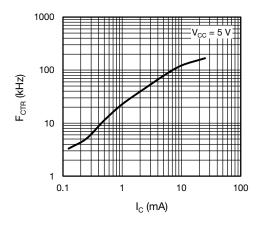


Fig. 14 - F_{CTR} vs. Collector Current

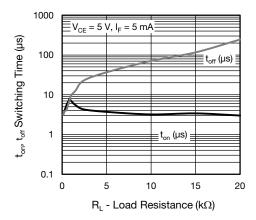
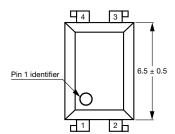
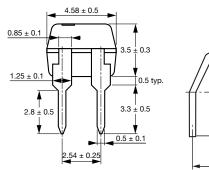


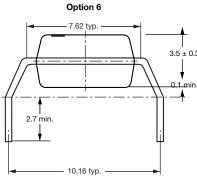
Fig. 15 - Switching Time vs. Load Resistance

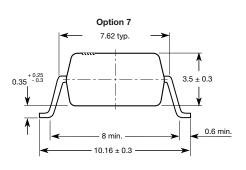


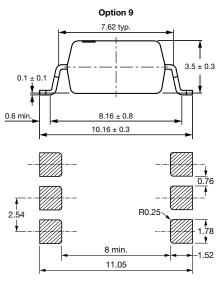
PACKAGE DIMENSIONS in millimeters











PACKAGE MARKING (example of VO617C-3X016)



Note

i178027-25

• Option information is not marked.

PACKING INFORMATION

DEVICE PER TUBE						
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX			
DIP-4	100	40	4000			

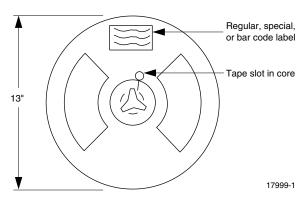


Fig. 16 - Tape and Reel Shipping Medium

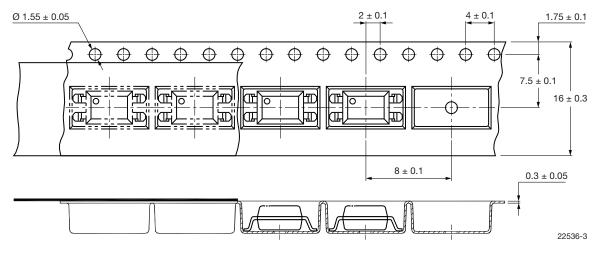


Fig. 17 - Tape Packing for Option 7 and 9 (1000 units per reel)

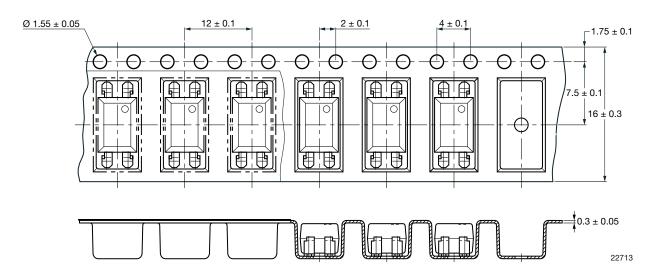


Fig. 18 - Tape Packing for Option 7 and 9, T1 rotation (2000 units per reel)



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